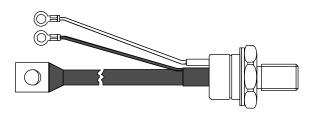


Vishay Semiconductors

Phase Control Thyristors (Stud Version), 80 A



TO-209AC (TO-94)

PRODUCT SUMMARY		
I _{T(AV)}	80 A	

FEATURES

- Hermetic glass-metal seal
- International standard case TO-209AC (TO-94)



- Compliant to RoHS directive 2002/95/EC
- Designed and qualified for industrial level

TYPICAL APPLICATIONS

- DC motor controls
- Controlled DC power supplies
- AC controllers

MAJOR RATINGS AND CHARACTERISTICS					
PARAMETER	TEST CONDITIONS	VALUES	UNITS		
		80	A		
I _{T(AV)}	T _C	85	°C		
I _{T(RMS)}		125			
I _{TSM}	50 Hz	1900	A		
	60 Hz	1990			
l²t	50 Hz	18	kA ² s		
rı	60 Hz	16	KA-S		
V _{DRM} /V _{RRM}		400 to 1200	V		
tq	Typical	110	μs		
T _J		- 40 to 125	°C		

ELECTRICAL SPECIFICATIONS

VOLTAGE RATINGS						
TYPE NUMBER	VOLTAGE CODE	V _{DRM} /V _{RRM} , MAXIMUM REPETITIVE PEAK AND OFF-STATE VOLTAGE V	V _{RSM} , MAXIMUM NON-REPETITIVE PEAK VOLTAGE V	I _{DRM} /I _{RRM} MAXIMUM AT T _J = 125 °C mA		
	40	400	500			
80RIA 81RIA	80	800	900	15		
	120	1200	1300			

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ABSOLUTE MAXIMUM RATINGS	5					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
Maximum average on-state current	I	180° condu	ction, half sine w	121/0	80	Α
at case temperature	I _{T(AV)}	100 Conduc	Juon, nan sine w	rave	85	s5 °C
Maximum RMS on-state current	I _{T(RMS)}	DC at 75 °C	case temperatu	re	125	
		t = 10 ms	No voltage		1900	
Maximum peak, one-cycle	I	t = 8.3 ms	reapplied		1990	A
non-repetitive surge current	I _{TSM}	t = 10 ms	100 % V _{RRM}		1600	
		t = 8.3 ms	reapplied	Sinusoidal half wave,	1675	
	l ² t	t = 10 ms	No voltage	initial $T_J = T_J$ maximum	18	kA ² s
Marriagna 12t for finding		t = 8.3 ms			16	
Maximum I ² t for fusing		t = 10 ms	100 % V _{RRM}		12.7	
		t = 8.3 ms	reapplied		11.7	
Maximum I ² √t for fusing	I²√t	t = 0.1 ms to 10 ms, no voltage reapplied		age reapplied	180.5	kA²√s
Low level value of threshold voltage	V _{T(TO)1}	(16.7 % x π	$x I_{T(AV)} < I < \pi x$	$I_{T(AV)}$, $T_J = T_J$ maximum	0.99	V
High level value of threshold voltage	V _{T(TO)2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.13	\ \ \	
Low level value of on-state slope resistance	r _{t1}	(16.7 % x π x $I_{T(AV)}$ < I < π x $I_{T(AV)}$), $T_J = T_J$ maximum		$I_{T(AV)}$), $T_J = T_J$ maximum	2.29	mΩ
High level value of on-state slope resistance	r _{t2}	$(I > \pi \times I_{T(AV)}), T_J = T_J \text{ maximum}$		1.84	1115.2	
Maximum on-state voltage	V_{TM}	I_{pk} = 250 A, T_J = 25 °C, t_p = 10 ms sine pulse		10 ms sine pulse	1.60	V
Maximum holding current	I _H	T _J = 25 °C, anode supply 12 V resistive load 200 400		W registive lead	200	mA
Typical latching current	l _L			400	IIIA	

SWITCHING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum non-repetitive rate of rise of turned-on current	dl/dt	T_J = 125 °C, V_d = Rated V_{DRM} , I_{TM} = 2 x dl/dt snubber 0.2 μF, 15 Ω , gate pulse: 20 V, 65 Ω , t_p = 6 μs, t_r = 0.5 μs Per JEDEC standard RS-397, 5.2.2.6.	300	A/µs
Typical delay time	t _d	Gate pulse: 10 V, 15 Ω source, t_p = 6 μ s, t_r = 0.1 μ s, V_d = Rated V_{DRM} , I_{TM} = 50 Adc, T_J = 25 °C	1	110
Typical turn-off time	tq	I_{TM} = 50 A, T_J = T_J maximum, dI/dt = - 5 A/ μ s, V_R = 50 V, dV/dt = 20 V/ μ s, gate bias: 0 V 25 Ω , t_p = 500 μ s	110	μs

BLOCKING				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum critical rate of rise of off-state voltage	dV/dt	T _J = 125 °C exponential to 67 % rated V _{DRM}	500	V/µs
Maximum peak reverse and off-state leakage current	I _{RRM} , I _{DRM}	T _J = 125 °C rated V _{DRM} /V _{RRM} applied	15	mA



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TRIGGERING					
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS
Maximum peak gate power	P _{GM}	$T_J = T_J$ maximum	, t _p ≤ 5 ms	12	W
Maximum average gate power	P _{G(AV)}	$T_J = T_J$ maximum	, f = 50 Hz, d% = 50	3	l vv
Maximum peak positive gate current	I _{GM}			3	Α
Maximum peak positive gate voltage	+ V _{GM}	$T_J = T_J \text{ maximum}$	$T_J = T_J$ maximum, $t_p \le 5$ ms		V
Maximum peak negative gate voltage	- V _{GM}			10	
Maximum DC gate current required to trigger		T _J = - 40 °C	Maximum required gate trigger/ current/voltage are the lowest value which will trigger all units 6 V anode to cathode applied	270	mA
	I _{GT}	T _J = 25 °C		120	
		T _J = 125 °C		60	
	V _{GT}	T _J = - 40 °C		3.5	V
Maximum DC gate voltage required to trigger		T _J = 25 °C		2.5	
		T _J = 125 °C		1.5	
DC gate current not to trigger	I _{GD}	T T manyimay ma	Maximum gate current/voltage not to trigger is the maximum value which will not trigger any unit with rated V _{DRM} anode to cathode applied	6	mA
DC gate voltage not to trigger	V _{GD}	$T_J = T_J \text{ maximum}$		0.25	V

THERMAL AND MECHANICAL SPECIFICATIONS				
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS
Maximum operating junction temperature range	TJ		- 40 to 125	°C
Maximum storage temperature range	T _{Stg}		- 40 to 150	
Maximum thermal resistance, junction to case	R _{thJC}	DC operation	0.30	K/W
Maximum thermal resistance, case to heatsink	R _{thCS}	Mounting surface, smooth, flat and greased	0.1	F\/ VV
		Non-lubricated threads	15.5 (137)	N⋅m
Mounting torque, ± 10 %		Lubricated threads	14 (120)	(lbf·in)
Approximate weight			130	g
Case style		See dimensions - link at the end of datasheet	TO-209AC	(TO-94)

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ΔR_{thJC} CONDUCTION						
CONDUCTION ANGLE	SINUSOIDAL CONDUCTION	RECTANGULAR CONDUCTION	TEST CONDITIONS	UNITS		
180°	0.042	0.030				
120°	0.050	0.052				
90°	0.064	0.070	$T_J = T_J$ maximum	K/W		
60°	0.095	0.100				
30°	0.164	0.165				

Note

• The table above shows the increment of thermal resistance R_{thJC} when devices operate at different conduction angles than DC

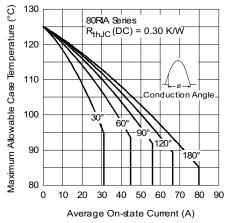


Fig. 1 - Current Ratings Characteristics

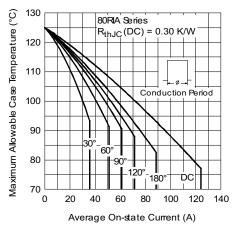


Fig. 2 - Current Ratings Characteristics

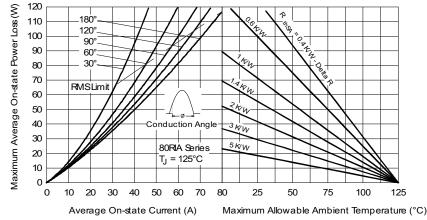


Fig. 3 - On-State Power Loss Characteristics



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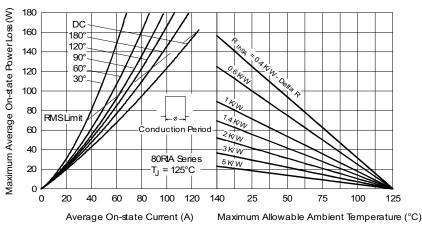


Fig. 4 - On-State Power Loss Characteristics

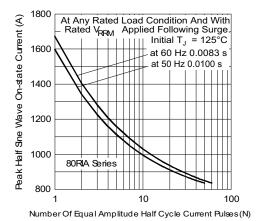


Fig. 5 - Maximum Non-Repetitive Surge Current

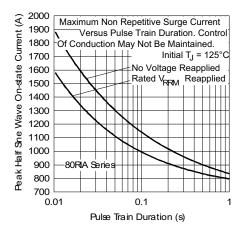


Fig. 6 - Maximum Non-Repetitive Surge Current

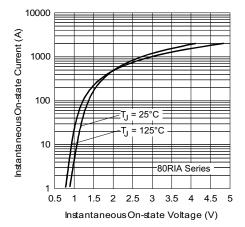


Fig. 7 - On-State Voltage Drop Characteristics

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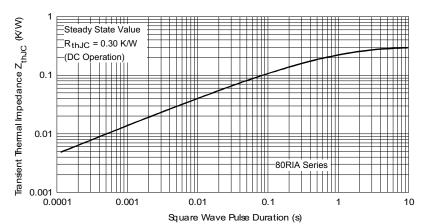
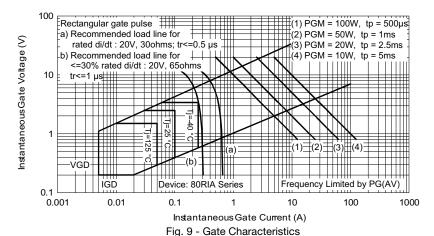
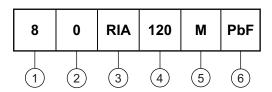


Fig. 8 - Thermal Impedance Z_{thJC} Characteristics



ORDERING INFORMATION TABLE

Device code



I_{TAV} x 10 A

• 0 = Eyelet terminals (gate and auxiliary cathode leads)

• 1 = Fast-on terminals (gate and auxiliary cathode leads)

• 2 = Flag terminals (gate and auxiliary cathode terminals)

RIA = Essential part number

Voltage code x 100 = V_{RRM} (see Voltage Ratings table)

• None = Stud base 1/2"-20UNF- 2 A threads

• M = Stud base metric threads M12 x 1.75 E 6

6 Lead (Pb)-free

LINKS TO RELATED DOCUMENTS		
Dimensions	www.vishay.com/doc?95362	

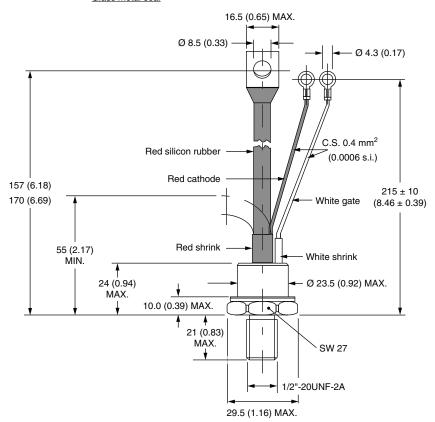


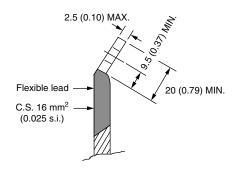
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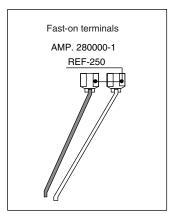
TO-209AC (TO-94) for 80RIA Series

DIMENSIONS in millimeters (inches)

Glass metal seal







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